

# TD351

### Advanced IGBT/MOSFET driver

### Features

- 1.7 A sink / 1.3 A source (typ) current capability
- Active Miller clamp feature
- Two-level turn-off with adjustable level and delay
- Input compatible with pulse transformer or optocoupler
- UVLO protection
- 2 kV ESD protection

### Applications

- 1200 V 3-phase inverters
- Motor control systems
- UPS

### Description

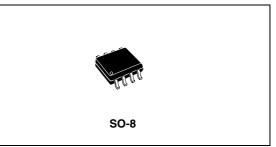
This device is an advanced gate driver for IGBT and power MOSFETs. Control and protection functions are included and allow the design of high reliability systems.

The innovative active Miller clamp function eliminates the need for negative gate drive in most applications and allows the use of a simple bootstrap supply for the high side driver.

The TD351 includes a two-level turn-off feature with adjustable level and delay. This function protects against excessive overvoltage at turn-off in case of overcurrent or short-circuit conditions. The same delay is applied at turn-on to prevent pulse width distortion.

#### Table 1.Device summary

Order codes	Temperature range	Package	Packaging	
TD351ID	-40°C, +125°C	SO-8	Tube	
TD351IDT	-40 0, +125 0	30-8	Tape and reel	



The TD351 is compatible with both pulse transformer and optocoupler signals.

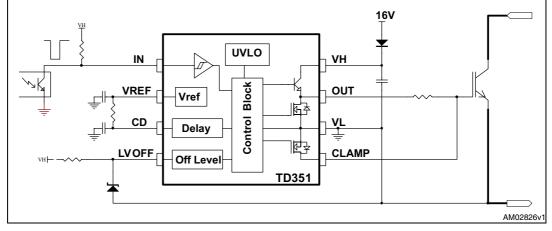
Doc ID 10977 Rev 2

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## 1 Block diagram



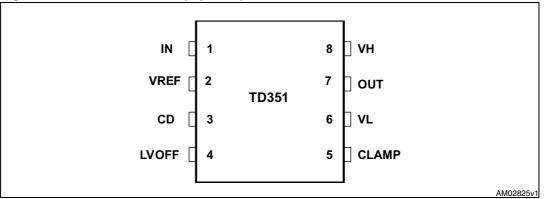




TD351

## 2 Pin connections

Figure 2.	Pin connections	(top view)



#### Table 2.Pin description

Pin n°	Name	Туре	Function
1	IN	Analog input	Input
2	VREF	Analog output	+5 V reference voltage
3	CD	Timing capacitor	Turn on/off delay
4	LVOFF	Analog input	Turn off level
5	CLAMP	Analog output	Miller clamp
6	VL	Power supply	Signal ground
7	OUT	Analog output	Gate drive output
8	VH	Power supply	Positive supply



## 3 Absolute maximum ratings

Symbol	Parameter	Value	Unit
VHL	Maximum supply voltage (VH - VL)	28	V
V <sub>out</sub>	Voltage on OUT, CLAMP, LVOFF pins	VL-0.3 to VH+0.3	V
Vother	Voltage on other pins (IN, CD, VREF)	-0.3 to 7	V
Pd	Power dissipation	500	mW
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
Тj	Maximum junction temperature	150	°C
R <sub>thJA</sub>	Thermal resistance junction-ambient	150	°C/W
ESD	Electrostatic discharge (HBM)	2	kV

#### Table 3. Absolute maximum ratings

#### Table 4.Operating conditions

Symbol	Parameter	Value	Unit
VH	Positive supply voltage vs. VL	UVLO to 26	V
T <sub>oper</sub>	Operating free air temperature range	-40 to 125	°C



## 4 Electrical characteristics

 $T_A$  = -20 to 125°C, VH = 16 V, unless otherwise specified.

 Table 5.
 Electrical characteristics

Symbol	Parameter	Test condition	Min	Тур	Max	Unit
Input						
V <sub>ton</sub>	IN turn-on threshold voltage		0.8	1.0		V
V <sub>toff</sub>	IN turn-off threshold voltage			4.0	4.2	V
t <sub>onmin</sub>	Minimum pulse width		100	135	220	ns
l <sub>inp</sub>	IN input current	IN input voltage < 4.5V			1	μA
Voltage refe	erence <sup>(1)</sup>			•		•
V <sub>ref</sub>	Voltage reference	T = 25°C	4.85	5.00	5.15	V
I <sub>ref</sub>	Maximum output current		10			mA
Clamp						
V <sub>tclamp</sub>	CLAMP pin voltage threshold			2.0		V
V <sub>CL</sub>	Clamp low voltage	I <sub>csink</sub> = 500mA			2.5	V
Delay						
V <sub>tdel</sub>	Voltage threshold			2.5		V
R <sub>del</sub>	Discharge resistor	I=1mA			500	
Off Level			1		1	1
I <sub>blvoff</sub>	LVOFF peak input current (sink)	LVOFF = 12V		90	200	μA
V <sub>iolv</sub>	Offset voltage	LVOFF = 12V	-0.3	-0.15	0	V
Output	·	·				
I <sub>sink</sub>	Output sink current	$V_{out} = 6V$	1000	1700		mA
I <sub>src</sub>	Output source current	V <sub>out</sub> = VH-6V	750	1300		mA
V <sub>OL1</sub>	Output low voltage 1	I <sub>osink</sub> = 20mA			0.35	V
V <sub>OL2</sub>	Output low voltage 2	I <sub>osink</sub> = 500mA			2.5	V
V <sub>OH1</sub>	Output high voltage 1	I <sub>osource</sub> = 20mA	VH-2.5			V
V <sub>OH2</sub>	Output high voltage 2	I <sub>osource</sub> = 500mA	VH-4.0			V
t <sub>r</sub>	Rise time	C <sub>L</sub> = 1nF, 10% to 90%			100	ns
t <sub>f</sub>	Fall time <sup>(2)</sup>	C <sub>L</sub> = 1nF, 90% to 10%			100	ns
t <sub>don</sub>	Turn on propagation delay	10% OUT change: $R_d = 4.7k\Omega$ , no $C_d$ $R_d = 10k\Omega$ , $C_d = 220$ pF	1.8	2.0	600 2.2	ns µs
t <sub>doff</sub>	Turn off propagation delay <sup>(2)</sup>	10% OUT change			550	ns



Symbol	Parameter	Test condition	Min	Тур	Max	Unit
$\Delta t_w$ Input to output pulse distortion		10% OUT change, $\Delta t_w = T_{wout} - T_{win}$		50	100	ns
Under volta	age lockout (UVLO)					
UVLOH	UVLO top threshold		10	11	12	V
UVLOL	UVLO bottom threshold		9	10	11	V
V <sub>hyst</sub>	UVLO hysteresis	UVLOH-UVLOL	0.5	1		V
Supply current						
l <sub>in</sub>	Quiescent current	OUT = 0V; no load			2.5	mA

Table 5. Electrical characteristics (continued)

1. Recommended capacitor range on VREF pin is 10 nF to 100 nF

2. 2 step turn-off disabled.



### 5 Functional description

#### 5.1 Input stage

The TD351 input is compatible with optocouplers or pulse transformers. The input is triggered by the signal edge and allows the use of low-sized, low-cost pulse transformers. Input is active low and output is driven high when input is driven low. The IN input is internally clamped at about 5 V to 7 V. When using an open collector optocoupler, the resistive pull-up resistor can be connected to either VREF or VH. Recommended pull-up resistor value with VH = 16 V is from 4.7 k $\Omega$  to 22 k $\Omega$  When driven by a pulse transformer, the input positive and negative pulse widths at the V<sub>ton</sub> and V<sub>toff</sub> threshold voltages must be larger than the minimum pulse width t<sub>onmin</sub> (see *Figure 6*). This feature acts as a filter against invalid input pulses smaller than t<sub>onmin</sub>.

### 5.2 Voltage reference

A voltage reference is used to create accurate timing for the turn-on delay with external resistor and capacitor. The same circuitry is also used for the two-level turn-off delay. A decoupling capacitor (10 nF to 100 nF) on the VREF pin is required to ensure good noise rejection.

### 5.3 Active Miller clamp

The TD351 offers an alternative solution to the problem of Miller current in IGBT switching applications. Instead of driving the IGBT gate to a negative voltage to increase the safety margin, the TD351 uses a dedicated CLAMP pin to control the Miller current. When the IGBT is off, a low impedance path is established between the IGBT gate and emitter to carry the Miller current, and the voltage spike on the IGBT gate is greatly reduced. During turn-off, the gate voltage is monitored and the clamp output is activated when the gate voltage goes below 2 V (relative to VL). The clamp voltage is VL+4V max for a Miller current up to 500 mA. The clamp is disabled when the IN input is triggered again.

The CLAMP function does not affect the turn-off characteristic, but only keeps the gate at low level throughout the OFF-time. The main benefit is that negative voltage can be avoided in many cases, allowing a bootstrap technique for the high side driver supply.

### 5.4 Two-level turn-off

During turn-off, the gate voltage can be reduced to a programmable level in order to reduce the IGBT current (in the event of overcurrent). This action prevents both dangerous overvoltages across the IGBT and RBSOA problems, especially at short-circuit turn-off.

The turn-off (T<sub>a</sub>) delay is programmable through external resistor  $\mathsf{R}_d$  and capacitor  $\mathsf{C}_d$  for accurate timing.



T<sub>a</sub> is approximately given by (see *Figure 5*):

$$T_a(\mu s) = 0.7 \cdot R_d(k\Omega) \cdot C_d(nF)$$

The turn-off delay  $(T_a)$  is also used to delay the input signal to prevent distortion of input pulse width.

The two-level turn-off sequence can be disabled by connecting the LVOFF pin to VH and connecting the CD pin to VREF with a 4.7 k $\Omega$  resistor.

#### 5.5 Minimum input ON-time

Input signals with ON-time smaller than T<sub>a</sub> are ignored.

ON-time signals larger than  $T_a+2 \cdot R_{del} \cdot C_d$  ( $R_{del}$  is the internal discharge switch resistance,  $C_d$  is the external timing capacitor) are transmitted to the output stage after the  $T_a$  delay, with minimum width distortion ( $\Delta T_w = T_{woin}^- T_{win}$ ).

For ON-time input signals close to  $T_a$  (between  $T_a$  and  $T_a+2 \cdot R_{del} \cdot C_d$ ), the two-level duration is slightly reduced and the total output width can be smaller than the input width (see *Figure 7*).

#### 5.6 Output stage

The output stage is able to sink/source 1.7 A/1.3 A (typical) at 25 °C and 1.0 A/0.75 A min. over the full temperature range. This current capability is specified near the usual IGBT Miller plateau.

### 5.7 Undervoltage protection

Undervoltage detection protects the application in the event of a low VH supply voltage (during startup or a fault situation). During undervoltage, the OUT pin is driven low (active pull-down for VH>2V, and passive pull-down for VH<2V).



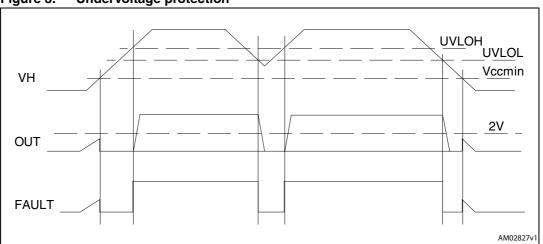


Figure 3. Undervoltage protection



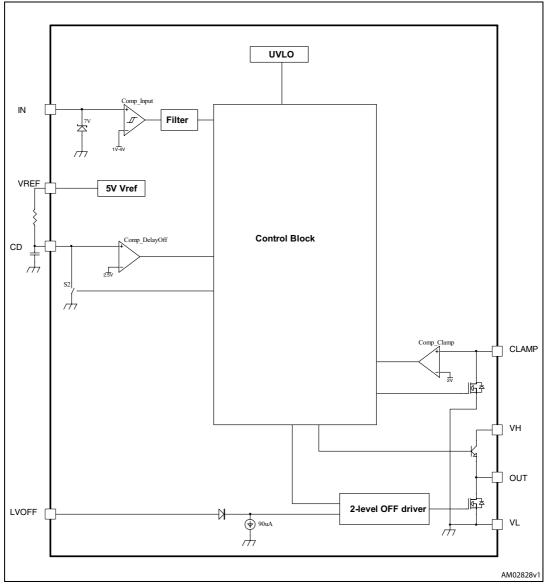


Figure 4. Detailed internal schematic



## 6 Timing diagrams

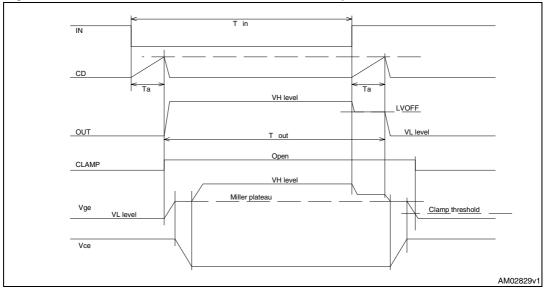
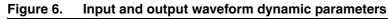
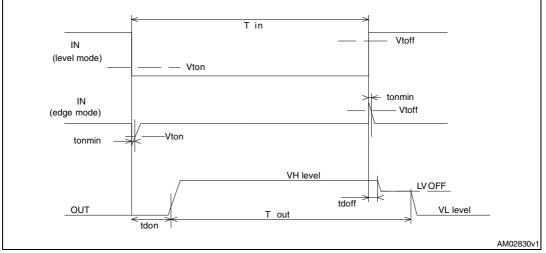


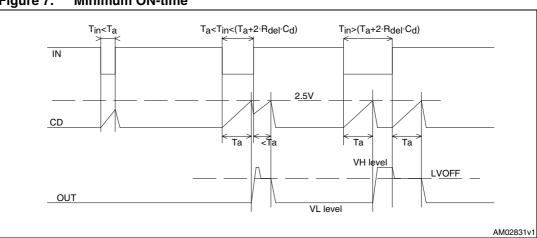
Figure 5. General turn-on and two-level turn-off sequence











#### Figure 7. Minimum ON-time



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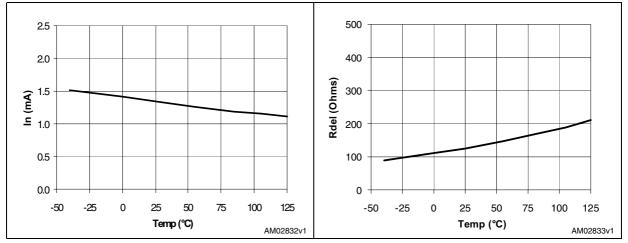


Figure 8. Quiescent current vs temperature Figure 9. Rdel resistance vs temperature

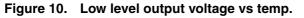
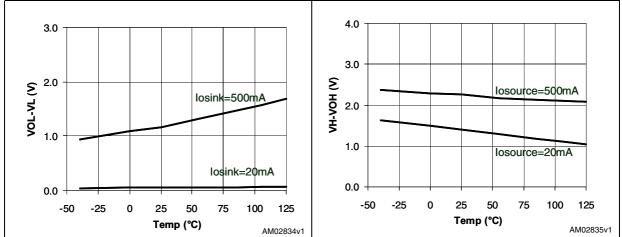
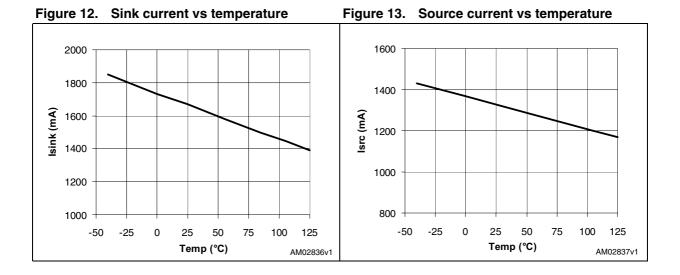


Figure 11. High level output voltage vs temp.





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#### TD351



## 8 Application diagrams

Figure 14. Single supply IGBT drive with active Miller clamp and opto input signal

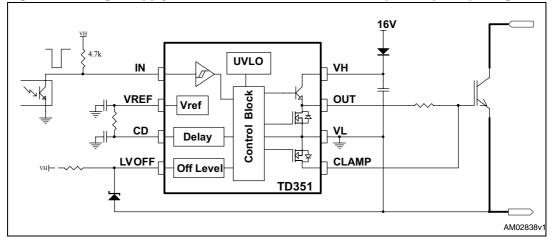


Figure 15. Single supply IGBT drive with active Miller clamp and pulse transformer input signal

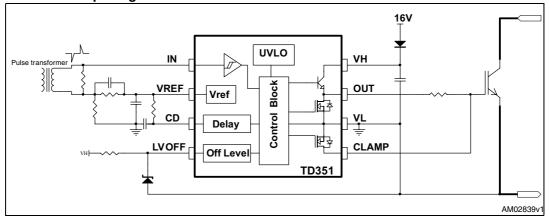
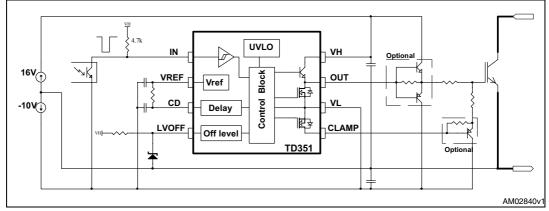


Figure 16. Large IGBT drive with negative voltage gate drive and optional current buffers





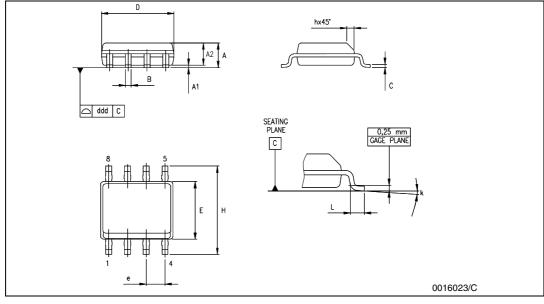
### 9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

Dim.	mm.			inch		
Dim.	Min.	Тур	Max.	Min.	Тур.	Max.
А	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
В	0.33		0.51	0.013		0.020
С	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
е		1.27			0.050	
Н	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	(max.) 8					
ddd			0.1			0.04

Table 6.SO-8 mechanical data

Figure 17. SO-8 mechanical drawing





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## 10 Revision history

#### Table 7.Document revision history

Date	Revision	Changes
01-Nov-2004	1	Initial release
16-Jun-2011	2	Removed order code TD351IN



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